



US00D894151S

(12) **United States Design Patent**
Nagamine et al.

(10) **Patent No.:** **US D894,151 S**

(45) **Date of Patent:** **** *Aug. 25, 2020**

(54) **HEADPHONE**

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(*) Notice: This patent is subject to a terminal disclaimer.

(**) Term: **15 Years**

(21) Appl. No.: **29/651,724**

(22) Filed: **Feb. 4, 2019**

(30) **Foreign Application Priority Data**

Aug. 15, 2018 (JP) 2018-017829

(51) **LOC (12) Cl.** **14-01**

(52) **U.S. Cl.**
USPC **D14/205**

(58) **Field of Classification Search**
USPC D14/205, 188, 192; D29/112; 2/209;
181/129, 130, 135; 379/430, 431;
381/380, 381, 370, 374; 455/90.3, 575.1,
455/569.1

CPC H04R 1/1066; H04R 1/1016; H04R 5/033;
H04R 5/0335; H04R 25/00; H04R
1/1091; H04R 1/1058; H04R 1/105
See application file for complete search history.

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(57) **CLAIM**

The ornamental design for a headphone, as shown and described.

DESCRIPTION

The patent or application file contains at least one drawing executed in color. Copies of this patent or patent application publication with color drawings will be provided by the Office upon request and payment of the necessary fee.

FIG. 1 is a perspective view of a headphone showing the new design;

FIG. 2 is a front elevational view of the headphone;

FIG. 3 is a rear elevational view of the headphone;

FIG. 4 is a top plan view of the headphone;

FIG. 5 is a bottom plan view of the headphone;

FIG. 6 is a left side elevational view of the headphone;

FIG. 7 is a right side elevational view of the headphone; and,

FIG. 8 is a front elevational view thereof with the headphones rotated.

The broken lines and ghosted areas depict environment that forms no part of the claimed design.

1 Claim, 8 Drawing Sheets
(8 of 8 Drawing Sheet(s) Filed in Color)



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Figure 1



Figure 2



Figure 3

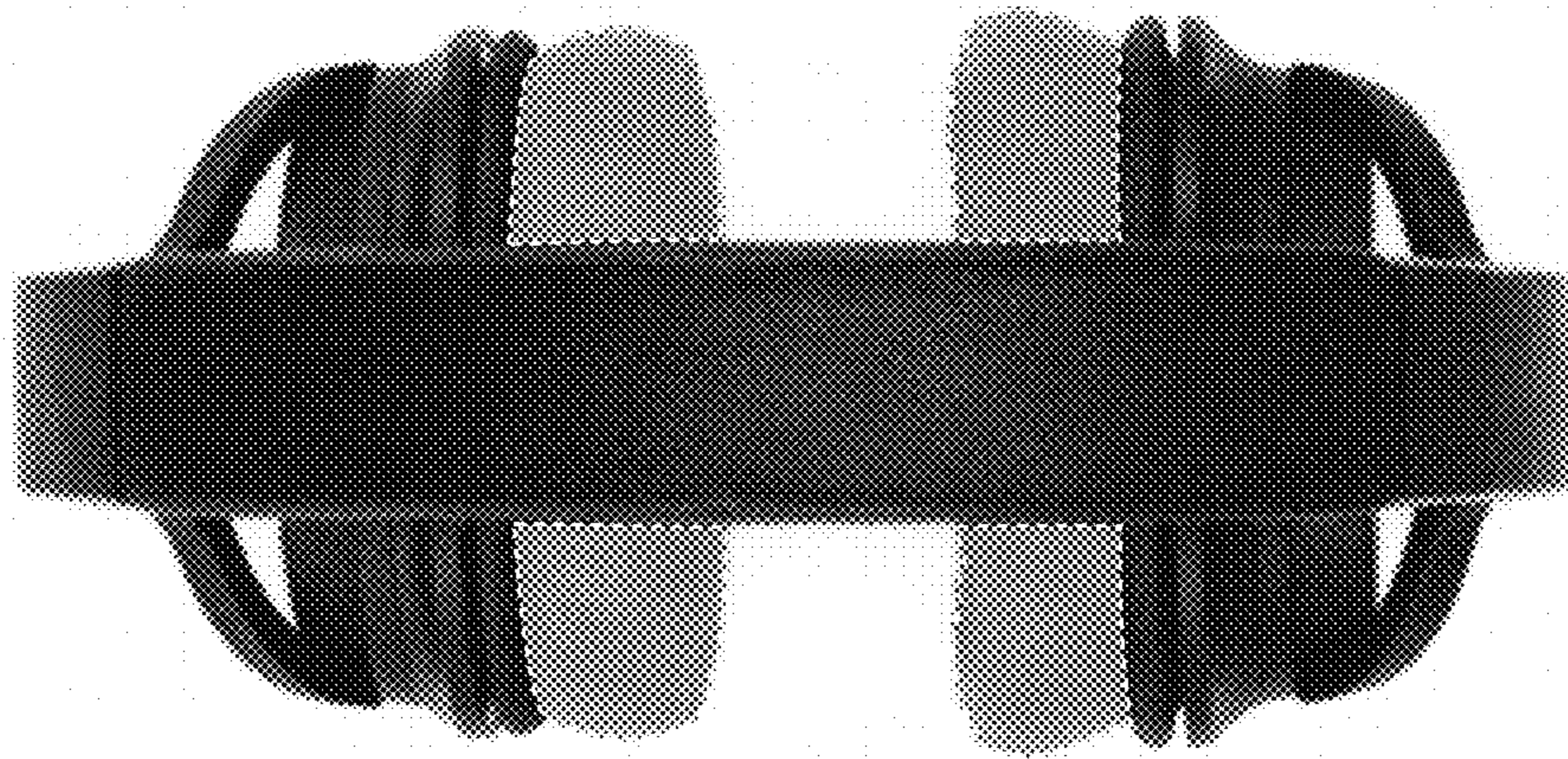


Figure 4

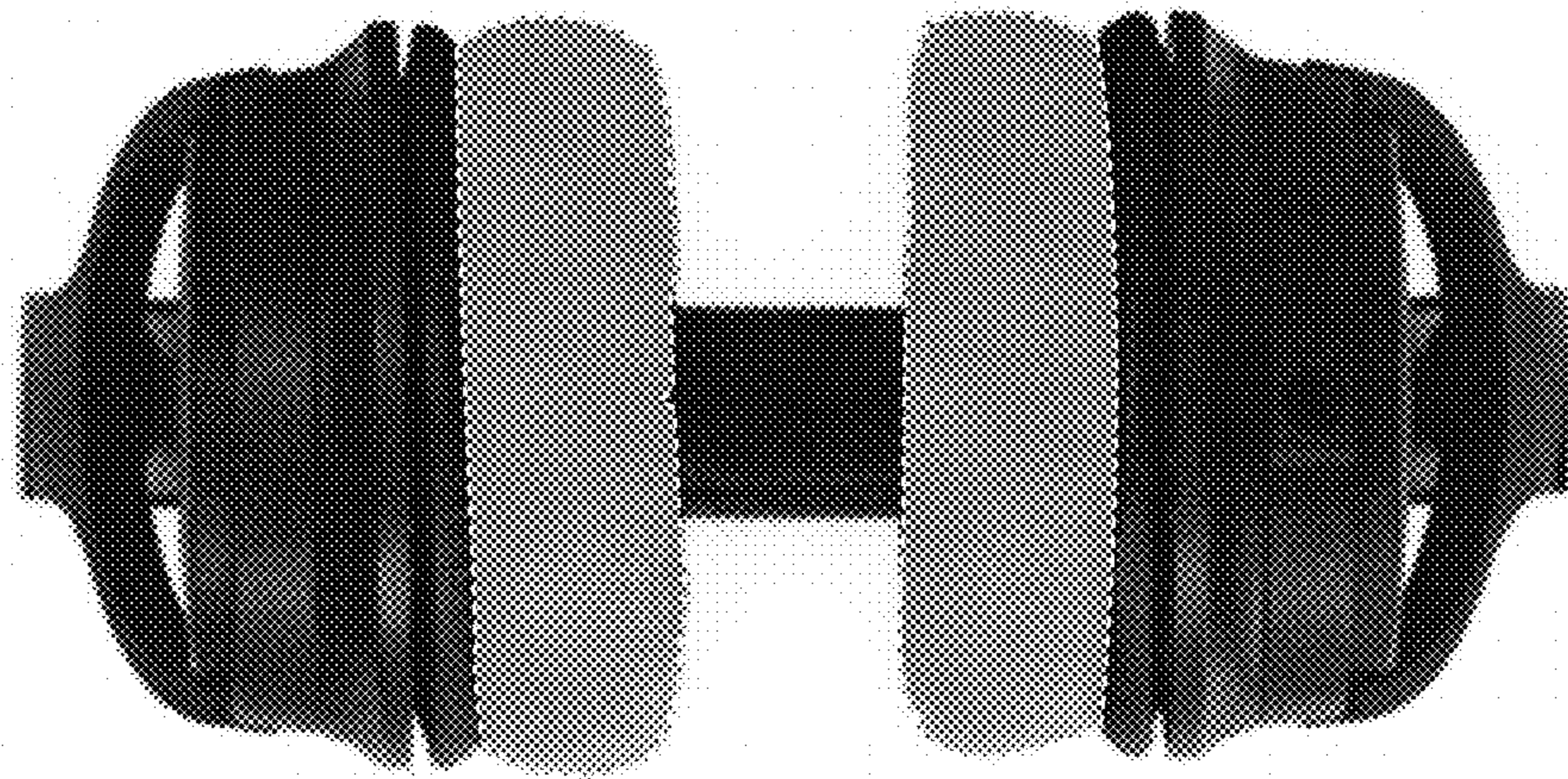


Figure 5



Figure 6



Figure 7



Figure 8